

BEST AVAILABLE COPY

UNITED STATES

DECLARATION FOR PATENT APPLICATION Docket No. SOH 14.569

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled STRUCTURE AND METHOD FOR MANUFACTURING A SEMICONDUCTOR
OPTICAL WAVEGUIDE

the specification of which

(check one) ☒ is attached hereto.

☐ I was filed on _____

Application Serial No. _____ as

and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(n).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)
8-289568

(Number)	Japan	31/10/1996	Priority Claimed
(Country)	(Day/Month/Year Filed)	Yes	No
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(Number)	(Country)	(Day/Month/Year Filed)	Yes No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(n) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)

I hereby appoint as my attorney and agent Aaron B. Karas, Reg. No. 18,923, Samson Helfgott, Reg. No. 23,072, Leonard Cooper Reg. No. 27,625 and Emma Shleifer, Reg. No. 29,734 to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Address all correspondence to:

HELFGOTT & KARAS P.C.
60th Floor
Empire State Building
New York, New York 10118-0110
Telephone No. (212) 643-5000

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Norihiro IWAI
Inventor's signature Norihiro Iwai Date 27/10/1997
Residence Tokyo, Japan Citizenship Japanese
Post Office Address 2-8-17, Futaba, Shinagawa-ku, Tokyo, Japan

Full name of second joint inventor, if any Kazuaki NISHIKATA
Second inventor's signature Kazuaki Date 27/10/1997
Residence Kanagawa, Japan Citizenship Japanese
Post Office Address 1-44-38-8-709, Ikeda-cho, Yokosuka-shi, Kanagawa, Japan

09886930.062501

Full name of additional inventor AKIHiko KASUKAWA
Inventor's signature Akihiko Kasukawa

Inventor's signature Hisako Katsukawa Date 27/10/1997
Residence Tokyo, Japan Citizenship Japanese
Post Office Address 3-15-8, Minami-Senzoku, Ohta-ku, Tokyo, Japan

Full name of additional inventor _____
 Second Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Second Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Second Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Second inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Second Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Inventor's signature _____
 Residence _____ Date _____
 Post Office Address _____ Citizenship _____

Full name of additional inventor _____
 Second Inventor's signature _____ Date _____
 Residence _____ Citizenship _____
 Post Office Address _____

05333930-062501

BEST AVAILABLE COPY

On : JUNE 25, 2001

Any fee due as a result of this paper, not covered by an enclosed check, may be charged on Deposit Acct. No. 08-1634.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assistant Commissioner for Patents
Washington, D.C. 20231

SIR:

Respectfully submitted,

HELFGOTT & KARAS, P.C.
60TH FLOOR
EMPIRE STATE BUILDING
NEW YORK, NEW YORK 10118
(212) 643-5000 DOCKET NO.:SOH 14.569A
SH:MIM:lnda:SOH14569A